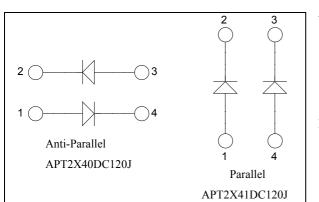
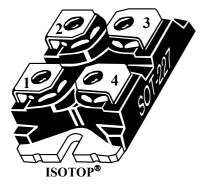


 $I_F = 40A$ @ $T_C = 100^{\circ}C$

ISOTOP[®] SiC Diode Power Module





Application

• Uninterruptible Power Supply (UPS)

 $V_{RRM} = 1200V$

- Induction heating
- Welding equipment
- High speed rectifiers

Features

- SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF
- ISOTOP[®] Package (SOT-227)
- Very low stray inductance
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

Absolute maximum ratings (per leg)

Symbol	Parameter			Max ratings	Unit
V _R	Maximum DC reverse Voltage			1200	V
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			1200	v
I _{F(AV)}	Maximum Average Forward Current	Duty cycle = 50%	$T_{\rm C} = 100^{\circ}{\rm C}$	40	٨
I _{FSM}	Non-Repetitive Forward Surge Cu	rrent 10 µs	$T_C = 25^{\circ}C$	500	А

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

APT2X41_40DC120J-Rev 1 October, 2012



All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

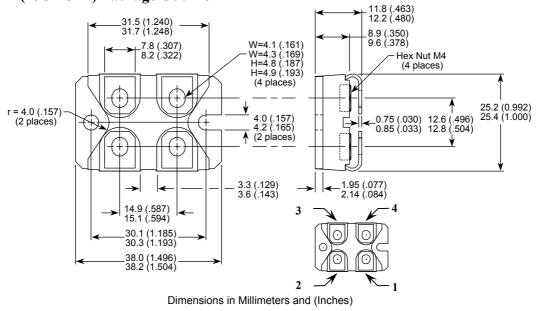
Electrical Characteristics (per leg)

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
$V_{\rm F}$	Diode Forward Voltage	$I_F = 40A$	$T_i = 25^{\circ}C$		1.6	1.8	V
			$T_i = 175^{\circ}C$		2.3	3.0	v
I _{RM}	Maximum Reverse Leakage Current	$V_{R} = 1200V$	$T_i = 25^{\circ}C$		128	800	μA
			$T_{i} = 175^{\circ}C$		224	4000	μЛ
Qc	Total Capacitive Charge	$I_F = 40A, V_R = 600V$ di/dt =2000A/µs			160		nC
С	Total Capacitance	$f = 1 MHz, V_R = 200 V$			384		pF
		$f = 1 MHz, V_R =$	400V		276		рг

Thermal and package characteristics (per leg)

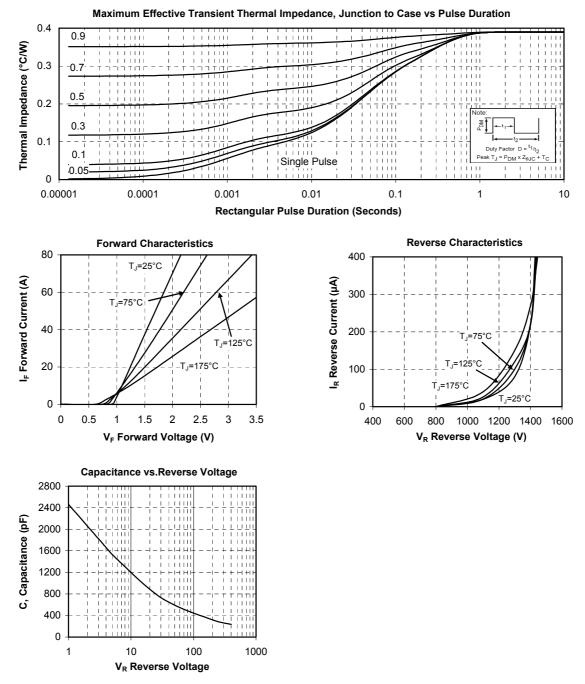
Symbol	Characteristic	Min	Тур	Max	Unit	
R _{thJC}	Junction to Case Thermal resistance			0.39	°C/W	
R _{thJA}	Junction to Ambient (IGBT & Diode)			20		
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz	2500			V	
T_J, T_{STG}	Storage Temperature Range	-55		175	°C	
$T_{\rm L}$	Max Lead Temp for Soldering:0.063" from case for 10 sec			300	C	
Torque	Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine)			1.5	N.m	
Wt	Package Weight		29.2		g	

SOT-227 (ISOTOP[®]) Package Outline





Typical Diode Performance Curve



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